Confirmation of product specifications **SPECIFICATIONS**

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Product	name:					
DESCR	RIPTION: E	luetooth ante	nna			
	er model:					
)MER PAR : model:	T No:				
		· PBX3216N	AC02			
Date:						
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PBX3216MC02 Specification

Operating Temp.: -40°C~+85°C

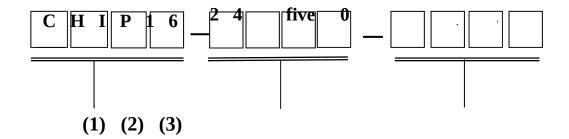
1. FEATURES:

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

2. APPLICATIONS:

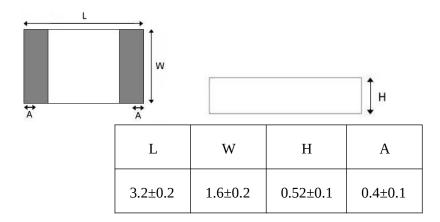
- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

3. PRODUCT IDENTIFICATION

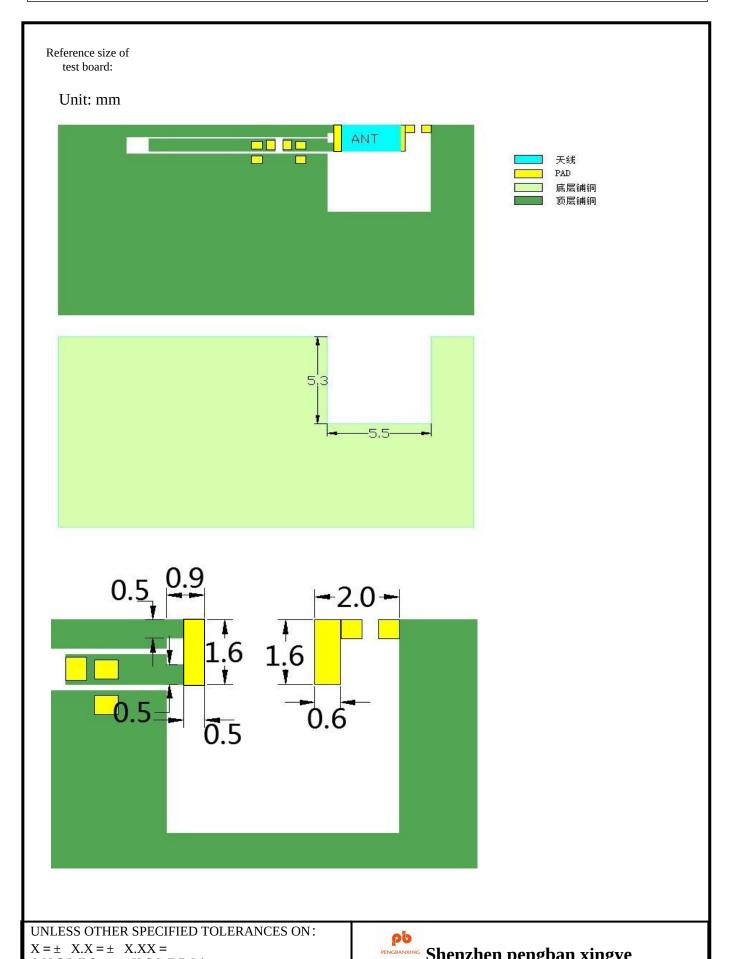


- (1) Product type: Multilayer chip Antenna
- (2) Center Frequency: 2450MHz
- (3) External Dimensions (L×W) (mm): 3.2*1.6

4. SHAPE AND DIMENSIONS:



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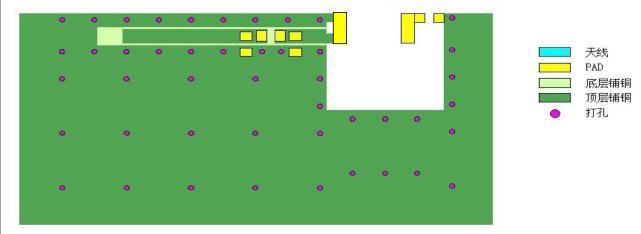


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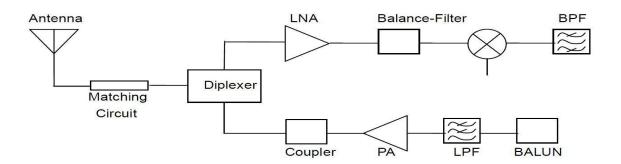
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Punching reference diagram



APPLICATION GUIDE



5. SPECIFICATIONS:

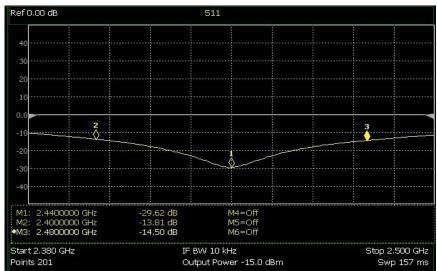
测试项	规格
带宽	2400~2483MHz
极化方式	线极化
*最大增益	2.67dBi
*效率	72.30%
输入阻抗 * Test condition: Test board	50 Ω size 90*40 mm

Matching circuit: Pi matching circuit will be required

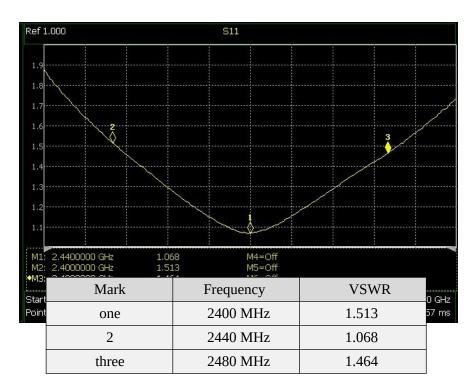
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6. Electrical Characteristics :

return loss



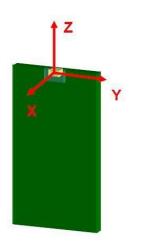
standing-wave ratio

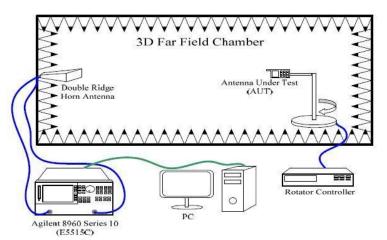


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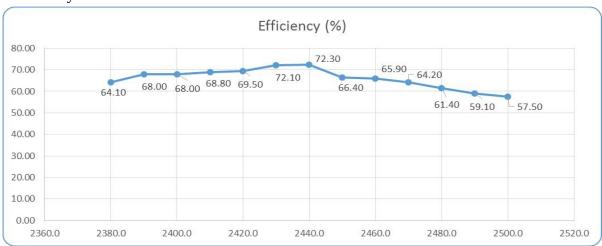
Radiation Pattern

The Gain pattern is measured in FAR-field chamber. DUT is placed on the table of rotator,a standard horn antenna and Vector Network Analyzer is used to collect data.



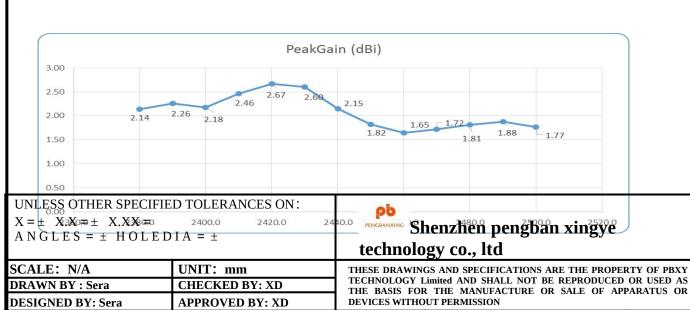


Efficiency



Maximum gain

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DOCUMENT

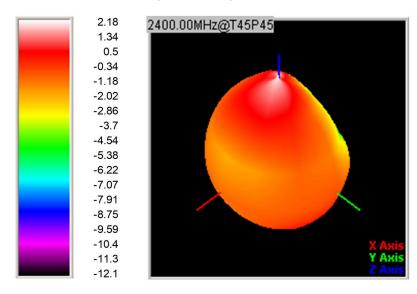
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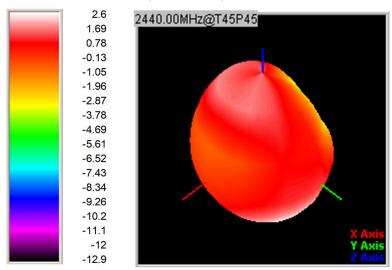
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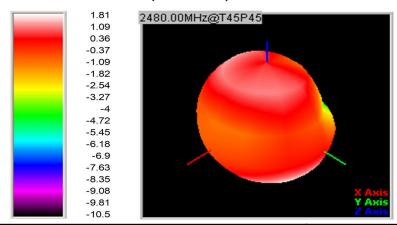
⊚ 3D Gain Pattern (2400 MHz)



⊚ 3D Gain Pattern (2440 MHz)



⊚ 3D Gain Pattern (2480 MHz)



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7. Environmental Characteristics

(1) Reliability Test

Item	Condition	Specification
Thermal shock	1. 30±3 minutes at -40° C±5° C, 2. Convert to +105° C (5 minutes) 3. 30±3 minutes at +105° C±5° C, 4. Convert to -40° C (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: $85\pm5^{\circ}$ C 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	1. Temperature: 150° C±5° C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Low temperature resistance	1. Temperature: -40° C±5° C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	1. Solder bath temperature : $260\pm5^{\circ}\!$	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245\pm5^\circ\mathrm{C}$ for 3 ± 1 seconds.	No apparent damage

(2) Storage Condition

(a) At warehouse:

The temperature should be within $0 \sim 30^{\circ}$ C and humidity should be less than 60% RH.

The product should be used within 1 year from the time of delivery.

(b) On board:

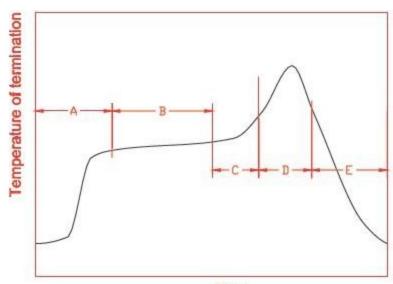
The temperature should be within $-40\sim85^{\circ}\mathrm{C}$ and humidity should be less than 85% RH.

(3) Operating Temperature Range

Operating temperature range : -40°C to +105°C.

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8. Recommended Reflow Soldering



Time

Α	1 st rising temperature	The normal to Preheating temperature	30s to 60s
В	Preheating	140°C to 160°C	60s to 120s
С	2 nd rising temperature	Preheating to 200°C	20s to 40s
		if 220°C	50s~60s
		if 230°C	40s∼50s
D	D Main heating	if 240°C	30s~40s
	property control part of COM A TV	if 250°C	20s~40s
		if 260°C	20s~40s
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s

^{*}reference: J-STD-020C

(1) Soldering Gun Procedure

Note the follows, in case of using solder gun for replacement.

- (a) The tip temperature must be less than 350°C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

(2) Soldering Volume

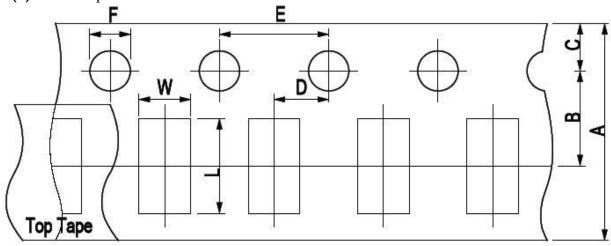
Note that excess of soldering volume will easily get crack the body of this product.

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9. Taping Package and Label Marking: (unit: mm)

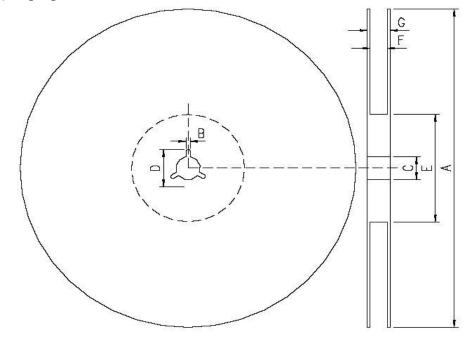
(1) Quantity/Reel: 5000pcs/Reel

(2) Carrier tape dimensions



Type	A	В	С	D	Е	F	L	W
2450-21	8.00 ± 0.3	3.50 ± 0.05	1.75±0.1	2.00 ± 0.05	4.00 ± 0.1	1.50 ± 0.1	2.30 ± 0.1	1.55 \pm 0.1

(3) Taping reel dimensions



9	
A	178.0±2.0
В	2.0±0.5
C	13.0±0.5
D	21.0±0.8
Ε	62.0±1.5
F	9.0±0.5
G	13.0±1.0

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